#### **General Description**

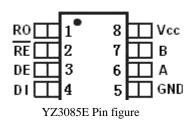
The YZ3085E is +/- 15kV electrostatic discharge (ESD) protected, high-speed transceiver for RS-485 communication that contain one driver and one receiver. The device features fail-safe circuitry, which guarantees a logic-high receiver output when the receiver inputs are open or shorted. This means that the receiver output will be logic-high even if all transmitters on a terminated bus are disabled. The YZ3085E features reduced slew-rate driver that minimizes EMI and reduces reflections caused by improperly terminated cables, allowing error-free data transmission up to 1Mbps. All transmitter outputs and receiver inputs are protected to +/- 15kV using the Human Body Model. The transceiver typically draws 200 micron ampere of supply current when unloaded, or when fully loaded with the driver disabled. This device has a 1/8-unit-load receiver input impedance that allows up to 256 transceivers on the bus. The YZ3085E is intended for half-duplex communications.

#### I/O ESD protection

Human Body Model: ±15kV

IEC 61000-4-2:

Contact discharge: ±12kV Air discharge: ±15kV



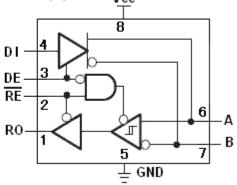
#### **Features**

- True Fail-Safe Receiver While Maintaining EIA/TIA-485 Compatibility
- Enhanced Slew-Rate Limiting Facilitates
   Error-Free Data Transmission
- Allow Up to 256 Transceivers on the Bus
- 1nA Low-Current Shutdown Mode

### **Applications**

- RS-485 Communications
- Level Translators
- Transceivers for EMI-Sensitive
   Applications
- Industrial Control Local Area Networks
- Energy Meter Networks
- Power Inverters
- Building Automation Networks
- Telecommunications Equipment

# PIN Configuration Configuration



#### **Ordering Information**

PART	Duplex	Data	Supply	Low- Power	Rx/Tx	IEC 61000-4-2	ТЕМР	PIN
PARI		Rate	Voltage	Shutdown	on Bus	Air discharge	RANGE	PACKAGE
YZ3085EESA	Half	1Mbps	5V	YES	256	±15kV	-40°C∼+85°C	8 SOP

Pin Description

PIN	NAME	FUNCTION
1	RO	Receiver Output. When RE is low and if A - B $\geq$ -50mV, RO will be high; if A- B $\leq$ -200mV, RO will be low.
2		Receiver Output Enable. Drive $\overline{RE}$ low to enable RO; RO is high impedance when $\overline{RE}$ is high. Drive $\overline{RE}$ high and DE low to enter low-power shutdown mode.
3	DE	Driver Output Enable. Drive DE high to enable driver outputs. These outputs are high impedance when DE is low. Drive $\overline{RE}$ high and DE low to enter low-power shutdown mode.
4	DI	Driver Input. With DE high, a low on DI forces non-inverting output low and inverting output high. Similarly, a high on DI forces non-inverting output high and inverting output low.
5	GND	Ground
6	A	Non-inverting Receiver Input and Non-inverting Driver Output.
7	В	Inverting Receiver Input and Inverting Driver Output.
8	VCC	Positive Supply $4.75V \le VCC \le 5.25V$ .

# ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	NUM	UNITS
Supply Voltage (VCC)	V <sub>CC</sub>	+7	V
Control Input Voltage ( \overline{RE} , DE)	$\overline{RE}$ , DE	-0.3 to V <sub>CC</sub> +0.3	V
Driver Input Voltage (DI)	DI	-0.3 toV <sub>CC</sub> +0.3	V
Driver Output Voltage (A, B)	A, B	±13	V
Receiver Input Voltage (A, B)	A, B	±13	V
Receiver Output Voltage (RO)	RO	-0.3~V <sub>CC</sub> +0.3	V
Continuous Power Dissipation	SOP8	471	mW
Operating Temperature Ranges		-40∼+85	$^{\circ}$ C
Storage Temperature Range		-65∼+150	$^{\circ}$ C
Lead Temperature (soldering, 10s)		300	$^{\circ}$ C

#### DC ELECTRICAL CHARACTERISTICS

 $(VCC = +5V \pm 5\%, TA = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.}$  Typical values are at VCC = +5V and TA = +25 °C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DRIVER						
Differential Driver Output (No Load)	V <sub>OD1</sub>	Figure 1	1.5		5	V
Differential Driver Output	$V_{\mathrm{OD2}}$	Figure 1, $R = 27\Omega$	1.5		5	V
Change-in-Magnitude of Differential Output Voltage (Note 2)	$\Delta V_{OD}$	Figure 1, $R = 27\Omega$			0.2	V
Driver Common-Mode Output Voltage	V <sub>oc</sub>	Figure 1, $R = 27\Omega$	1		3	V

YZ3085E

							<del>                                      </del>
Change-in-Magnitude of							
Common-Mode Voltage	$\Delta V_{OC}$	Figure 1, $R = 27\Omega$			0.2	V	
(Note 2)							
Input High Voltage	$V_{\mathrm{IH1}}$	DE, DI, $\overline{RE}$		2.0			V
Input Low Voltage	$V_{IL1}$	DE, DI, RE				0.8	V
DI Input Hysteresis	$V_{\mathrm{HYS}}$				100		mV
Leavet Comment (A and D)		DE = GND, VCC =	$V_{IN}=12V\\$			125	4
Input Current (A and B)	$I_{IN1}$	GND or 5.25V	$V_{IN} = -7V$	-75			μΑ
		-7V ≦V <sub>OUT</sub> ≦VCC		-250			
Driver Short-Circuit Output Current (Note 3)	$I_{OSD}$	$0V \leq V_{OUT} \leq 12V$				250	mA
(INOTE 3)		0V ≤V <sub>OUT</sub> ≤VCC		±25			
RECEIVER							
Receiver Differential Threshold Voltage	$V_{TH}$	-7V ≤V <sub>CM</sub> ≤12V		-200	-110	-50	mV
Receiver Input Hysteresis	$\Delta V_{TH}$				30		mV
Receiver Output High Voltage	$V_{\mathrm{OH}}$	$I_{O} = -4 \text{mA}, V_{ID} = -50 \text{mV}$	V	V <sub>CC</sub> -			V
Receiver Output Low Voltage	V <sub>OL</sub>	$I_{O} = 4mA, V_{ID} = -200m^{3}$	V			0.4	V
Three-State Output Current at Receiver	$I_{OZR}$	$0.4V \leq V_O \leq 2.4V$				±1	μΑ
Receiver Input Resistance	R <sub>IN</sub>	-7V ≦V <sub>CM</sub> ≤ 12V		96			kΩ
Receiver Output Short-Circuit Current	$I_{OSR}$	$0V \leq V_{RO} \leq VCC$		±7		±95	mA
SUPPLY CURRENT							
Supply Current	$I_{CC}$	110 1044,	DE = VCC DE = GND		155 160	900 600	μΑ
Supply Current in Shutdown Mode	$I_{SHDN}$	$DE = GND \text{ or } VCC \qquad DE = GND$ $DE = GND, V \overline{RE} = VCC$			0.001	10	μΑ
ESD Protection for A, B		Human Body Model			±15		kV

# SWITCHING CHARACTERISTICS

 $(VCC = +5V \pm 5\%, TA = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } VCC = +5V \text{ and } T_A = +25 \text{ } ^{\circ}\text{C.})$ 

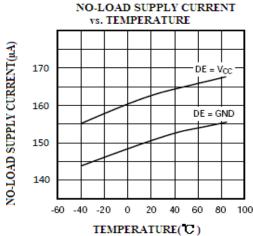
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Driver Input to Output	t <sub>DPLH</sub>	Figure 3, $R_{DIFF} = 54\Omega$ ,	250	720	900	
Driver Input to Output	t <sub>DPHL</sub>	$C_{L1} = C_{L2} = 100 pF$	250	720	900	ns
Driver Output Skew   t <sub>DPLH</sub> - t <sub>DPHL</sub>	t <sub>DSKEW</sub>	Figure 3, $R_{DIFF}$ =54 $\Omega$ $C_{L1}$ = $C_{L2}$ =100pF		-3	±100	ns
Driver Rise or Fall Time	$t_{\mathrm{DR}},t_{\mathrm{DF}}$	Figure 3, $R_{DIFF} = 54\Omega$ , $C_{L1} = C_{L2} = 100 \text{pF}$	200	530	750	ns

Maximum Data Rate	f <sub>MAX</sub>				1000	Kbps
Driver Enable to Output High	t <sub>DZH</sub>	Figure 4, C <sub>L</sub> =100pF, S2 closed			2500	ns
Driver Enable to Output Low	t <sub>DZL</sub>	Figure 4, C <sub>L</sub> =100pF, S1 closed			2500	ns
Driver Disable Time from Low	t <sub>DLZ</sub>	Figure 4, C <sub>L</sub> = 15pF, S1 closed			100	ns
Driver Disable Time from High	t <sub>DHZ</sub>	Figure 4, $C_L = 15pF$ , S2 closed			100	ns
Receiver Input to Output	t <sub>RPLH,</sub> t <sub>RPHL</sub>	Figure 5, $\mid V_{ID} \mid \ge 2.0 V$ rise and fall time of $V_{ID} \le 15 ns$		127	200	ns
$\mid t_{RPLH} - t_{RPHL} \mid$ Differential Receiver Skew	t <sub>RSKD</sub>	Figure 5, $\mid V_{ID} \mid \ge 2.0 V$ rise and fall time of $V_{ID} \le 15 ns$		3	±30	ns
Receiver Enable to Output Low	t <sub>RZL</sub>	Figure 2, C <sub>L</sub> =100pF, S1 closed		20	50	ns
Receiver Enable to Output High	t <sub>RHZ</sub>	Figure 2, C <sub>L</sub> =100pF, S2 closed		20	50	ns
Receiver Disable Time from Low	t <sub>RLZ</sub>	Figure 2, C <sub>L</sub> =100pF, S1 closed		20	50	ns
Receiver Disable Time from High	t <sub>RHZ</sub>	Figure 2, C <sub>L</sub> =100pF, S2 closed		20	50	ns
Time to Shutdown	t <sub>SHDN</sub>	(Note 4)	50	200	600	ns
Driver Enable from Shutdown-to-Output High	t <sub>DZH(SHDN)</sub>	Figure 4, C <sub>L</sub> = 15pF,S2 closed			4500	ns
Driver Enable from Shutdown-to-Output Low	t <sub>DZL(SHDN)</sub>	Figure 4, C <sub>L</sub> = 15pF,S1 closed			4500	ns
Receiver Enable from Shutdown-to-Output High	t <sub>RZH(SHDN)</sub>	Figure 2, C <sub>L</sub> =100pF,S2 closed			3500	ns
Receiver Enable from Shutdown-to-Output Low	t <sub>RZL(SHDN)</sub>	Figure 2, C <sub>L</sub> =100pF,S1 closed			3500	ns

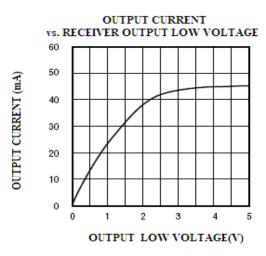
- **Note 1:** All currents into the device are positive; all currents out of the device are negative. All voltages are referred to device ground unless otherwise noted.
- Note 2:  $\Delta V_{OD}$  and  $\Delta V_{OC}$  are the changes in  $V_{OD}$  and  $V_{OC}$ , respectively, when the DI input changes state.
- **Note 3:** Maximum current level applies to peak current just prior to fold-back current limiting; minimum current level applies during current limiting.
- Note 4: The device is put into shutdown by bringing  $\overline{RE}$  high and DE low. If the enable inputs are in this state for less than 50ns, the device is guaranteed not to enter shutdown. If the enable inputs are in this state for at least 600ns, the device is guaranteed to have entered shutdown.

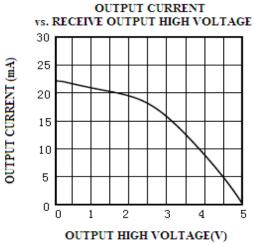
# **Typical Operating Characteristics**

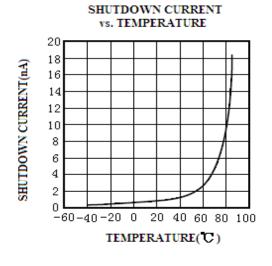
(VCC = +5V, TA = +25 °C, unless otherwise noted.)

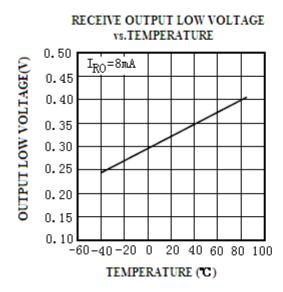


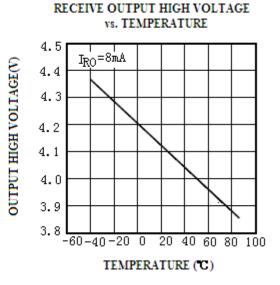












(\$00Kbps MODE)vs. TEMPERATURE

140

CLOAD = 100pF

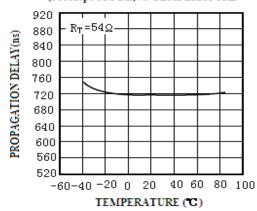
130

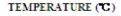
125

120

RECEIVE PROPAGATION DELAY

DRIVER PROPAGATION DELAY (500Kbps MODE)vs. TEMPERATURE

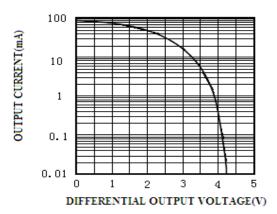




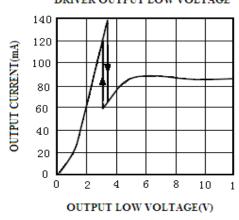
-40 -20 0 20 40 60 80 100

115\_60

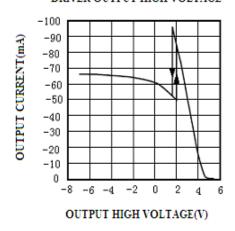
DRIVER OUTPUT CURRENT vs. DIFFERENTIAL OUTPUT VOLTAGE



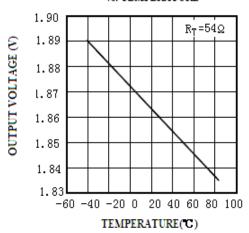
OUTPUT CURRENT vs.
DRIVER OUTPUT LOW VOLTAGE



OUTPUT CURRENT vs.
DRIVER OUTPUT HIGH VOLTAGE



DRIVER DIFFERENTIAL OUTPUT VOLTAGE vs. TEMPERATURE



# **Function Tables**

TRANSMITTING							
	INPUTS		OUTPUTS				
$\overline{RE}$	DE	DI	В	A			
X	1	1	0		1		
X	1	0	1		0		
0	0	X	High-	Z	High-Z		
1	0	X	Shutdown				
		RECEIVING	<u>;</u>				
	INPUTS	S			OUTPUTS		
	DE	A - 1	В		RO		
0	X	≧-0.2	2V		1		
0	X	≦-0.2	≤-0.2V 0				
0	X	Open/sh	orted		1		
1	1	X			High-Z		
1	0	X	X		Shutdown		

X = Don't care

Shutdown mode, driver and receiver outputs high impedance

# Test Circuits

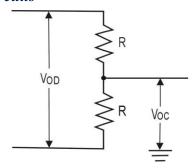


Figure 1. Driver DC Test Load

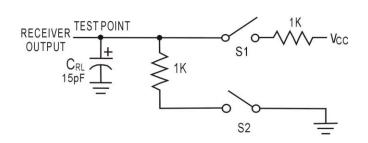


Figure 2. Receiver Enable/Disable Timing Test Load

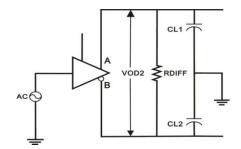


Figure 3. Driver Timing Test Load

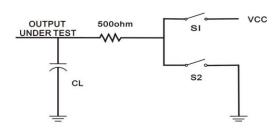


Figure 4. Driver Enable/Disable Timing Test Load

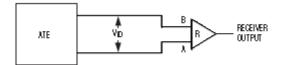


Figure 5. Receiver Propagation Delay Test Load

#### **Detailed Description**

The YZ3085E high - speed transceiver for RS-485 communication contains one driver and one receiver. These devices feature fail-safe circuitry, which guarantees a logic-high receiver output when the receiver inputs are open or shorted, or when they are connected to a terminated transmission line with all drivers disabled (see the Fail-Safe section). The YZ3085E feature reduced slew-rate driver that minimizes EMI and reduces reflections caused by improperly terminated cables, allowing error-free data transmission up to 500kbps (see the Reduced EMI and Reflections section). The YZ3085E is a half-duplex transceiver. The voltage operates from a single +5V supply. Drivers are output short-circuit current limited. Thermal shutdown circuitry protects drivers against excessive power dissipation. When activated, the thermal shutdown circuitry places the driver outputs into a high impedance state.

#### Receiver Input Filtering

The receiver of the YZ3085E, when operating in 1Mbps, incorporates input filtering in addition to input hysteresis. This filtering enhances noise immunity with differential signals that have very slow rise and fall times. Receiver propagation delay increases by 25% due to this filtering.

#### Fail-Safe

The YZ3085E guarantees a logic-high receiver output when the receiver inputs are shorted or open, or when they are connected to a terminated transmission line with all drivers disabled. This is done by setting the receiver threshold between -50mV and -200mV. If the input voltage of differential receiver (A-B) is greater than or equal to -50mV, RO is logic high. If A-B is less than or equal to -200mV, RO is logic low. In the case of a terminated bus with all transmitters disabled, the receiver differential input voltage is pulled to 0V by the termination. With the receiver threshold of the YZ3085E, this results in a logic high with a 50mV minimum noise margin. Unlike previous fail-safe devices, the -50mV to -200mV threshold complies with the +/-200mV EIA/TIA-485 standard.

#### **ESD Protection**

As with YZ3085E, ESD-protection structures are incorporated on all pins to protect against electrostatic discharges encountered during handling and assembly. The driver output and receiver input of the YZ3085E has extra protection against static electricity. The ESD-protected pins are tested with reference to the ground pin in a powered-down condition.

They are tested to +/- 15kV using the Human Body Model.

#### ESD Test Conditions

ESD performance depends on a variety of conditions. Contact Maxim for a reliability report that documents test setup, test methodology, and test results.

#### **Human Body Model**

Figure 6a shows the Human Body Model, and Figure 6b shows the current waveform it generates when discharged into a low impedance. This model consists of a 100pF capacitor charged to the ESD voltage of interest, which is then discharged into the test device through a  $1.5 \mathrm{k}\Omega$  resistor.

#### Machine Model

The Machine Model for ESD tests all pins using a 200pF storage capacitor and zero discharge resistance. The objective is to emulate the stress caused when I/O pins are contacted by handling equipment during test and assembly. All pins require this protection, not just RS-485 inputs and outputs.

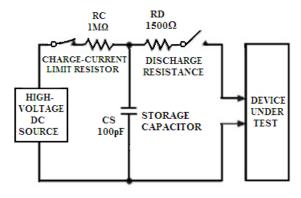


Figure 6a. Human Body ESD Test Model

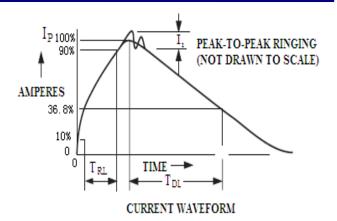


Figure 6b. Human Body Current Waveform

# Applications Information 256 Transceivers on the Bus

The standard RS-485 receiver input impedance is  $12k\Omega$  (one-unit load), and the standard driver can drive up to 32 unit loads. The YZ3085E has a 1/8-unit-load receiver input impedance (96k $\Omega$ ), allowing up to 256 transceivers to be connected in parallel on one communication line. Any combination of this device and/or other RS-485 transceivers with a total of 32 unit loads or less can be connected to the line.

#### Reduced EMI and Reflections

The YZ3085E, is slew-rate limited, minimizing EMI and reducing reflections caused by improperly terminated cables. High-frequency harmonic components with large amplitudes are evident. transmitting under the same conditions. Figure 7 shows driver output waveform and its Fourier analysis of a 20kHz signal transmitted by a YZ3085E, In general, a transmitter's rise time relates directly to the length of an unterminated stub, which can be driven with only minor waveform reflections. The following equation expresses this relationship conservatively:

Length =  $t_{RISE}$  / (10 x 1.5ns/ft) where  $t_{RISE}$  is the transmitter's rise time. For example, the YZ3085E's rise time is typically 1320ns, which results in excellent waveforms with a stub length up to 90 feet. A system can work well with longer unterminated stubs, even with severe reflections, if the waveform settles out before the UART samples them.

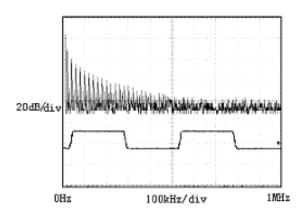


Figure 7. Driver Output Waveform and FFT Plot of YZ3085E Transmitting a 20kHz Signal

#### Low-Power Shutdown Mode

When both the driver and receiver are disabled (DE low and RE high) the device is in shutdown mode. If the enable inputs are in this state for less than 60 ns, the device does not enter shutdown mode. This guards against inadvertently entering shutdown mode during driver/receiver enabling. Only when the enable inputs are held in this state for 300 ns or more, the device is assured to be in shutdown mode. In this low-power shutdown mode, most internal circuitry is powered down except over temperature protection circuit, and the supply current is typically 40 micron ampere. When either the driver or the receiver is re-enabled, the internal circuitry becomes active. If only the driver is re-enabled (DE changed to high) the driver outputs are driven according to the DI input after the enable times given by t<sub>PZH</sub>(SHDN) and t<sub>PZL</sub> (SHDN) in the driver switching characteristics. If the DI

input is open when the driver is enabled, the driver outputs defaults to A high and B low, in accordance with the driver failsafe feature. If only the receiver is re-enabled (RE changed to low) the receiver output is driven according to the state of the bus inputs (A and B) after the enable time given by t<sub>PZH</sub>(SHDN) and t<sub>PZL</sub>(SHDN) in the receiver switching characteristics. If there is no valid state on the bus the receiver responds as described in the failsafe operation section. If both the receiver and driver are re-enabled simultaneously, the receiver output is driven according to the state of the bus inputs (A and B) and the driver output is driven according to the DI input. Note that the state of the active driver affects the inputs to the receiver. Therefore, the receiver outputs are valid as soon as the driver outputs are valid.

#### **Driver Output Protection**

Two mechanisms prevent excessive output current and power dissipation caused by faults or by bus contention. The first, a fold back current limit on the output stage, provides immediate protection against short circuits over the whole common-mode voltage range. The second, a thermal shutdown circuit, forces the driver outputs into a high-impedance state if the die temperature becomes excessive.

#### Line Length vs Data Rate

The RS-485/RS-422 standard covers line lengths up to 4000 feet. For line lengths greater than 4000 feet, use the repeater application

shows in Figure 8. Figure 9 shows the system differential voltage for the parts driving 4000 feet of 26AWG twistedpair wire at 110kHz into  $120\Omega$  loads.

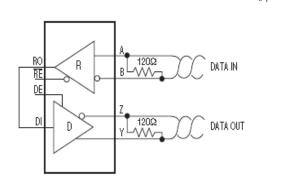


Figure 8. Line Repeater for YZ3085E

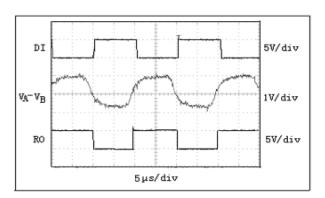


Figure 9.YZ3085E System Differentia Voltage at 50kHz

Driving 4000ft of Cable

# **Applications**

The YZ3085E transceiver is designed for bidirectional data communications on multipoint bus transmission lines. Figures 10 shows typical network applications circuits. To minimize reflections, the line should be terminated at both ends in its characteristic impedance, and stub lengths off the main line should be kept as short as possible. The slew-rate-limited YZ3085E is more tolerant of imperfect termination.

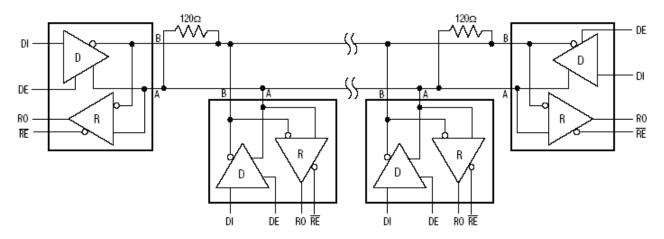


Figure 10. YZ3085E Pin Configuration and Typical Half-Duplex Operating Circuit

